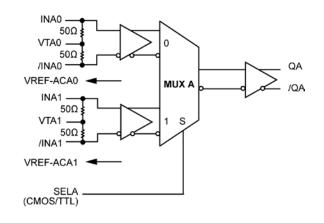
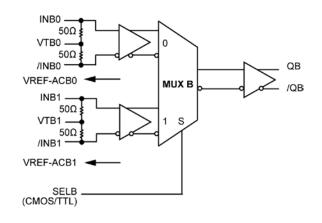
Functional Block Diagram





Truth Table

SEL	Q	
0	IN0 Input Select	
1	IN1 Input Select	

Ordering Information⁽¹⁾

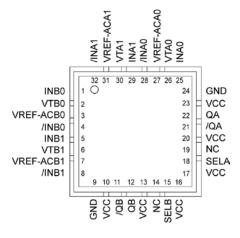
Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY89853UMG	QFN-32	Industrial	SY89853U with Pb-Free bar-line indicator	NiPdAu Pb-Free
SY89853UMGTR ⁽²⁾	QFN-32	Industrial	SY89853U with Pb-Free bar-line indicator	NiPdAu Pb-Free

Notes:

1. Contact factory for die availability. Dice are guaranteed at $T_A = 25^{\circ}C$, DC Electricals only.

2. Tape and Reel.

Pin Configuration





Pin Description

Pin Number	Pin Name	Pin Function	
25, 28, 29, 32 1, 4 5, 8	INA0, /INA0, INA1, /INA1, INB0, /INB0, INB1, /INB1	Differential Inputs: These input pairs are the differential signal inputs to the device. Inputs accept AC- or DC-coupled signals as small as 100mV. Each pin of a pair internally terminates to a VT pin through 50Ω . Note that these inputs will default to an indeterminate state if left open. Connecting one input to VCC and the complementary input-to-GND through $1k\Omega$ resistor can terminate unused differential input pairs. The VT pin is to be left open in this configuration. Please refer to the "Input Interface Applications" section for more details.	
10, 13, 16, 17, 20, 23	VCC	ositive power supply. Bypass with $0.1\mu F/0.01\mu F$ low ESR capacitors. The $0.01\mu F$ apacitor should be as close to VCC pin as possible.	
14, 19	NC	Not connected.	
18 15	SELA, SELB	Bank A and Bank B Input Channel Select (TTL/CMOS): These TTL/CMOS-compatible inputs select the inputs to the multiplexers. These inputs are internally connected to a $25k\Omega$ pull-up resistor and will default to logic HIGH state if left open.	
22, 21 12, 11	QA, /QA, QB, /QB	Differential Outputs: These LVPECL output pairs are the outputs of the device. They are a logic function of the INA0, INA1, INB0, INB1 and SELA and SELB inputs. Please refer to the "Truth Table" below for details.	
26, 30 2, 6	VTA0, VTA1 VTB0, VTB1	Input Termination Center-Tap: Each side of the differential input pair terminates to a VT pin. The VTA0, VTA1, VTB0, VTB1 pins provide a center-tap to a termination network for maximum interface flexibility. See "Input Interface Applications" section for details.	
27 31 3 7	VREF-ACA0, VREF-ACA1, VREF-ACB0, VREF-ACB1	Reference Voltages: These reference voltage outputs are equivalent to V _{CC} -1.2V. They are used for AC-coupled inputs. Connect VREF-AC directly to the VT pin and bypass with 0.01 μ F low ESR capacitor to V _{CC} . See "Input Interface Applications" section. Maximum sink/source current is ±1.5mA.	
9, 24	GND, Exposed Pad	Ground: Ground pins and exposed pad must be connected to the same ground plane.	

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Absolute Maximum Ratings⁽¹⁾

Supply Voltage (V_{CC})0.5V to +4.0V Input Voltage (V_{IN})0.5V to V_{CC} LVPECL Output Current (I_{OUT})
Continuous±50mA
Surge ±100mA
Termination Current
Source or Sink Current on V _T ±50mA
Input Current
Source or Sink Current on IN, /IN ±50mA
Current (V _{REF-AC})
Source or Sink Current on V _{REF-AC} ±2mA
Lead Temperature (soldering, 20sec.)
Storage Temperature (T_s)65°C to +150°C

Operating Ratings⁽²⁾

Supply Voltage (V _{CC})	+2.375V to +2.625V
	+3.0V to +3.6V
Ambient Temperature (T _A)	–40°C to +85°C
Ambient Temperature (T _A) Package Thermal Resistance ⁽³⁾	
QFN (θ _{JA})	
Still-Air	35°C/W
500lfpm	28°C/W
QFN (Ψ _{JB})	
Junction-to-Board	16°C/W

DC Electrical Characteristics⁽⁴⁾

 $T_A = -40^{\circ}C$ to +85°C, unless otherwise noted.

Symbol	Parameter	Condition	Min	Тур	Max	Units
Vcc	Power Supply	$V_{CC} = 2.5V$ $V_{CC} = 3.3V$	2.375 3.0	2.5 3.3	2.625 3.6	V V
Icc	Power Supply Current	No load, max. V _{CC} .		65	85	mA
R _{IN}	Input Resistance (IN-to-VT)		45	50	55	Ω
$R_{\text{DIFF}_\text{IN}}$	Differential Input Resistance (IN-to-/IN)		90	100	110	Ω
VIH	Input High Voltage (IN, /IN)	Note 5	V _{cc} - 1.6		Vcc	V
VIL	Input Low Voltage (IN, /IN)		0		V _{IH} — 0.1	V
V _{IN}	Input Voltage Swing (IN-to-/IN)	See Figure 1a.	0.1		1.7	V
$V_{\text{DIFF}_\text{IN}}$	Differential Input Voltage Swing IN - /IN	See Figure 1b.	0.2			V
V_{T_IN}	Maximum Input Voltage (IN-to-V⊤)				1.28	V
V _{REF-AC}	Output Reference Voltage		V _{cc} - 1.3	V _{cc} - 1.2	V _{cc} - 1.1	V

Notes:

 Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum ratings conditions for extended periods may affect device reliability.

2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.

3. Package thermal resistance assumes exposed pad is soldered (or equivalent) to the devices most negative potential on the PCB. θ_{JA} and ψ_{JB} values are determined for a 4-layer board in still-air, unless otherwise stated.

4. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

5. V_{IH} (min) not lower than 1.2V.

LVPECL Outputs DC Electrical Characteristics⁽⁵⁾

 V_{CC} = 2.5V ±5% or 3.3V ±10%; R_L = 50 Ω to V_{CC} -2V; T_A = -40°C to +85°C, unless otherwise noted.

Symbol	Parameter	Condition	Min	Тур	Max	Units
V _{OH}	Output High Voltage (Q, /Q)		V _{CC} -1.145		V _{CC} -0.895	V
V _{OL}	Output Low Voltage (Q, /Q)		V _{CC} -1.945		V _{CC} -1.695	V
V _{OUT}	Output Voltage Swing (Q, /Q)	See Figure 1a.	400	800		mV
V _{DIFF-OUT}	Differential Output Voltage Swing (Q, /Q)	See Figure 1b.	800	1600		mV

LVTTL/CMOS DC Electrical Characteristics⁽⁵⁾

 V_{CC} = 2.5V ±5% or 3.3V ±10%; T_A = -40°C to +85°C, unless otherwise noted.

Symbol	Parameter	Condition	Min	Тур	Max	Units
VIH	Input High Voltage		2.0			V
VIL	Input Low Voltage				0.8	V
Ін	Input High Current	$V_{IN} = V_{CC}$			75	μA
IIL	Input Low Current	$V_{IN} = 0.5V$	-300			μΑ

Notes:

5. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

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AC Electrical Characteristics⁽⁶⁾

 V_{CC} = 2.5V ±5% or 3.3V ±10%; T_A = -40°C to + 85°C, R_L = 50 Ω to V_{CC} -2V, unless otherwise stated.

Symbol	Parameter	Condition	Min	Тур	Max	Units
f _{MAX}	Maximum Operating Frequency	NRZ Data	2.5			Gbps
		Clock, V _{OUT} > 400mV	2.5			GHz
t _{pd}	Propagation Delay					
	IN-to-Q		160	250	360	ps
	SEL-to-Q		100	260	400	ps
t _{pd} Tempco	Differential Propagation Delay Temperature Coefficient			143		fs/ ºC
t _{SKEW}	Input-to-Input Skew (Within-bank)	Note 7		10	20	ps
	Bank-to-Bank Skew	Note 8		12	25	ps
t _{JITTER}	Data					
	Random Jitter (RJ)	Note 9			1	ps _{RMS}
	Deterministic Jitter (DJ)	Note 10			10	PSPP
	Clock					
	Cycle-to-Cycle Jitter	Note 11			1	ps _{RMS}
	Total Jitter (TJ)	Note 12			10	ps _{PP}
	Crosstalk-Induced Jitter					
	Channel-to-Channel (Within-bank)	Note 13, within-bank			0.7	ps _{RMS}
t _{r,} t _f	Output Rise/Fall Time (20% to 80%)	At full output swing.	50	100	180	ps

Notes:

6. High-speed AC parameters are guaranteed by design and characterization. V_{IN} swing \geq 100mV, unless otherwise stated.

7. Input-to-input skew is the difference in time between two inputs to the output within a bank.

8. Bank-to-bank skew is the difference in time from input to the output between banks.

9. Random jitter is measured with a K28.7 character pattern, measured at $< f_{MAX}$.

10. Deterministic jitter is measured at 2.5Gbps with both K28.5 and 2²³-1 PRBS pattern.

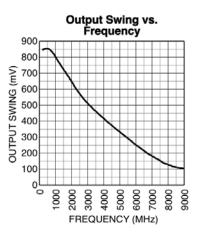
11. Cycle-to-cycle jitter definition: the variation of periods between adjacent cycles, T_n – T_{n-1} where T is the time between rising edges of the output signal.

12. Total jitter definition: with an ideal clock input of frequency <f_{MAX}, no more than one output edge in 10¹² output edges will deviate by more than the specified peak-to-peak jitter value.

13. Crosstalk is measured at the output while applying two similar differential clock frequencies that are asynchronous with respect to each other at the inputs.

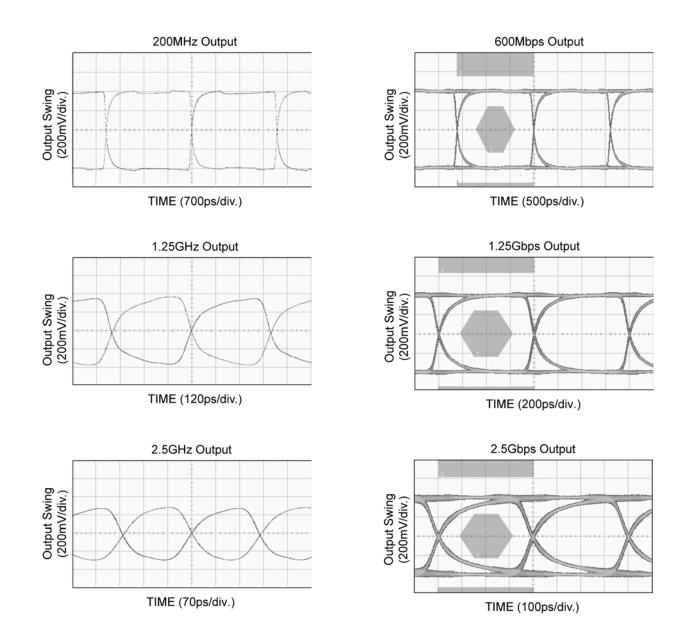
Typical Operating Characteristics

 V_{CC} = 3.3V ±10%; T_A = –40°C to + 85°C, R_L = 50 Ω to V_{CC} –2V, unless otherwise stated.

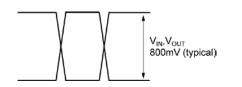


Functional Characteristics

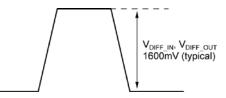
 V_{CC} = 3.3V ±10%; T_A = –40°C to + 85°C, R_L = 50 Ω to V_{CC} –2V, unless otherwise stated.



Single-Ended and Differential Swings

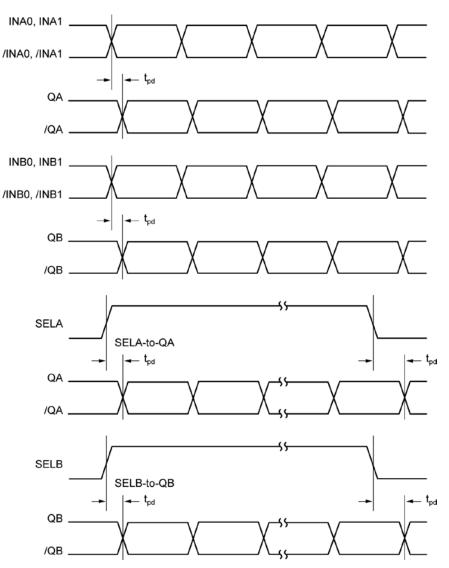








Timing Diagram



Input and Output Stages

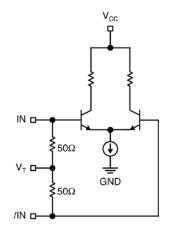


Figure 2a. Simplified Differential Input Stage

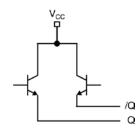
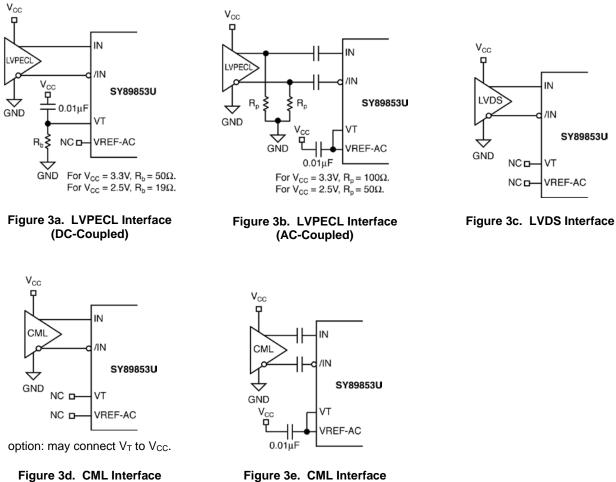


Figure 2b. Simplified LVPECL Output Stage

Input Interface Applications



(AC-Coupled)

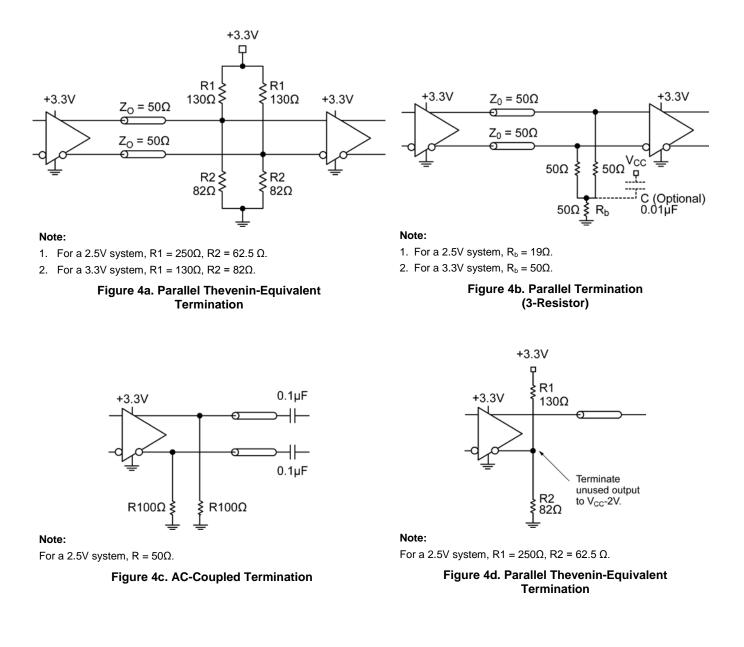
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(DC-Coupled)

Output Interface Applications

LVPECL has high input impedance, very low output (open emitter) impedance, and small signal swing, which result in low EMI. LVPECL is ideal for driving 50Ω and 100Ω controlled impedance transmission lines. There are different techniques for terminating

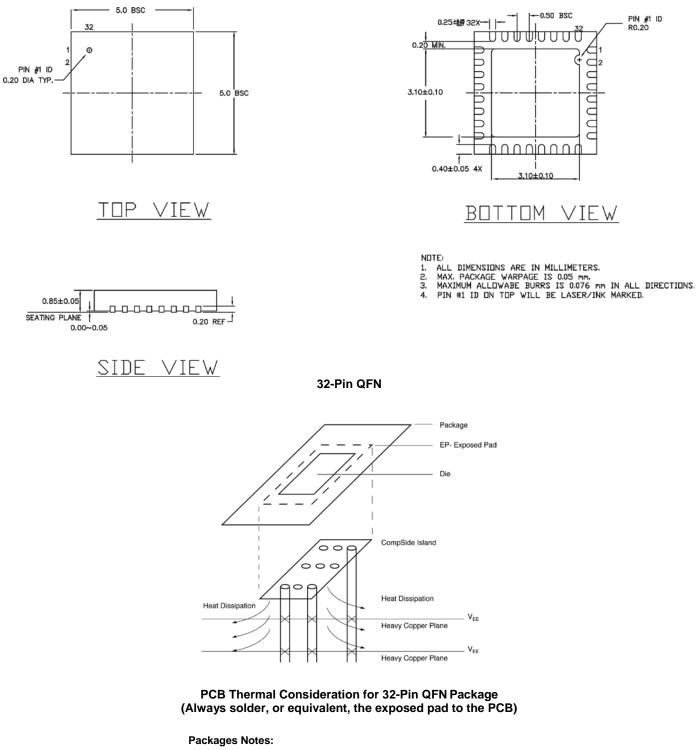
LVPECL outputs: Parallel Termination Thevenin-Equivalent, Parallel Termination (3-resistor), and ACcoupled termination. Unused output pairs may be left floating; however, single-ended outputs must be terminated or balanced.



Related Product and Support Documentation

Part Number	Function	Data Sheet Link
SY58026U	5Gbps Dual 2 :1 400mV LVPECL MUX with Internal Termination	www.micrel.com/product-info/products/sy58026u.shtml.
HBW Solutions	New Products and Applications	www.micrel.com/product-info/products/solutions.shtml

Package Information



- 1. Package meets Level 2 Moisture Sensitivity Classification.
- 2. All parts are dry-packed before shipment.
- 3. Exposed pads must be soldered to a ground for proper thermal management.

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